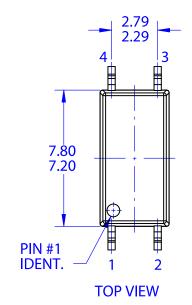


SSOP4 / LSOP04 CASE 565BH ISSUE O

DATE 31 JAN 2017



4.10

3.50

FRONT VIEW

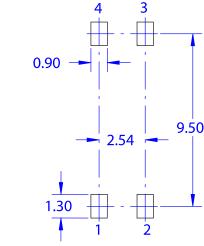
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0.30

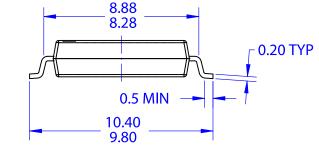
2.20 1.80

0.20

0.00



LAND PATTERN RECOMMENDATION



SIDE VIEW

NOTES: A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE

B. ALL DIMENSIONS ARE IN MILLIMETERS

C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS

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